

74LVT2245; 74LVTH2245

3.3 V octal transceiver with 30 Ω termination resistors; 3-state

Rev. 5 — 10 April 2017

Product data sheet

1 General description

The 74LVT2245; 74LVTH2245 is a high-performance BiCMOS product designed for V_{CC} operation at 3.3 V.

This device is an octal transceiver featuring non-inverting 3-state bus compatible outputs in both send and receive directions. The control function implementation minimizes external timing requirements. The device features an output enable input (\overline{OE}) for easy cascading and a direction input (DIR) for direction control.

The 74LVT2245; 74LVTH2245 is designed with 30 Ω series resistance in both the HIGH-state and LOW-state of the output. This design reduces line noise in applications such as memory address drivers, clock drivers and bus transceivers and transmitters.

2 Features and benefits

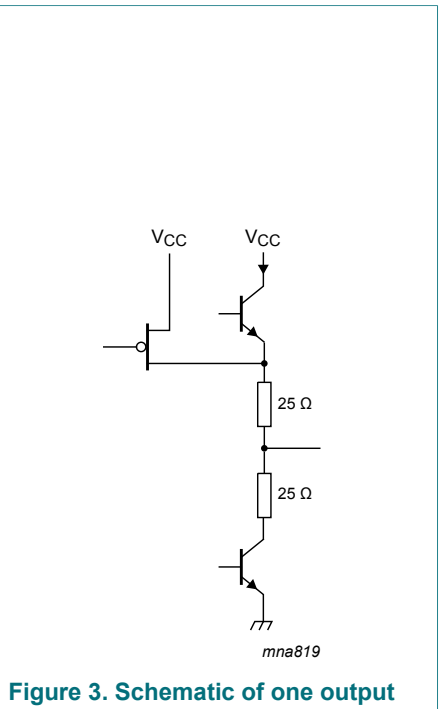
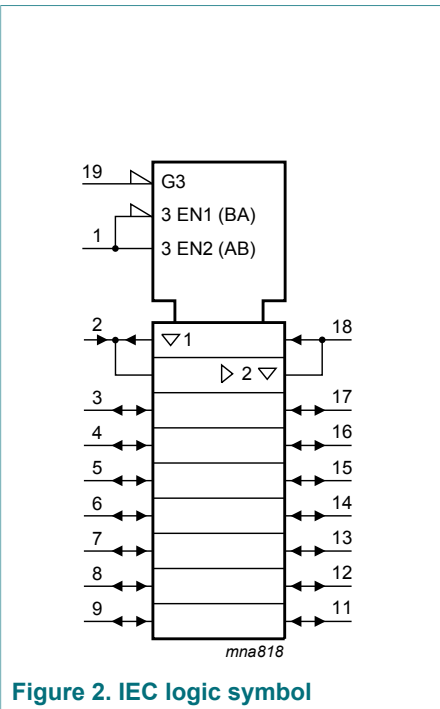
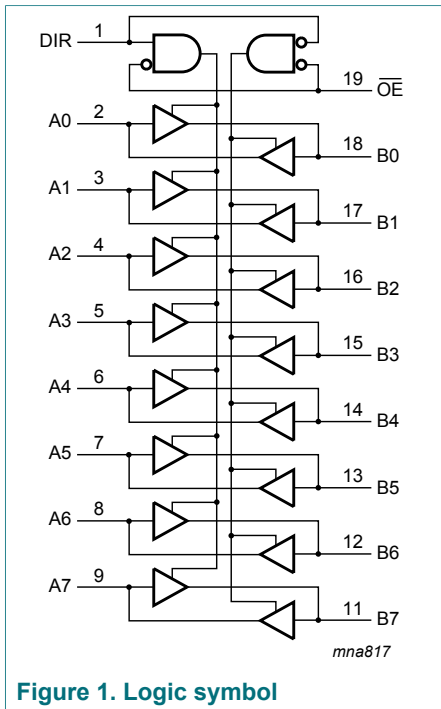
- 30 Ω output termination resistors
- Octal bidirectional bus interface
- 3-state buffers
- Output capability: +12 mA and -12 mA
- TTL input and output switching levels
- Input and output interface capability to systems at 5 V supply
- Bus hold data inputs eliminate need for external pull-up resistors to hold unused inputs
- Live insertion and extraction permitted
- Power-up 3-state
- No bus current loading when output is tied to 5 V bus
- Latch-up protection:
 - JESD78: exceeds 500 mA
- ESD protection:
 - MIL STD 883 method 3015: exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)

3 Ordering information

Table 1. Ordering information

| Type number | Package | | | Version |
|--------------|-------------------|---------|--|----------|
| | Temperature range | Name | Description | |
| 74LVT2245D | -40 °C to +85 °C | SO20 | plastic small outline package; 20 leads; body width 7.5 mm | SOT163-1 |
| 74LVTH2245D | | | | |
| 74LVT2245DB | -40 °C to +85 °C | SSOP20 | plastic shrink small outline package; 20 leads; body width 5.3 mm | SOT339-1 |
| 74LVTH2245DB | | | | |
| 74LVT2245PW | -40 °C to +85 °C | TSSOP20 | plastic thin shrink small outline package; 20 leads; body width 4.4 mm | SOT360-1 |
| 74LVTH2245PW | | | | |

4 Functional diagram



5 Pinning information

5.1 Pinning

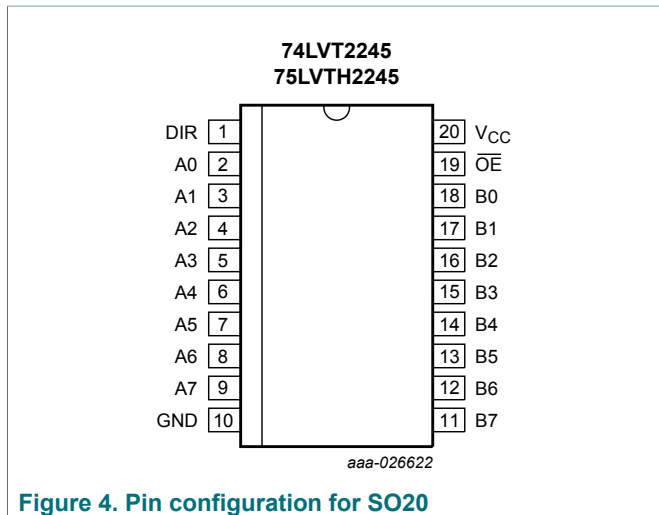


Figure 4. Pin configuration for SO20

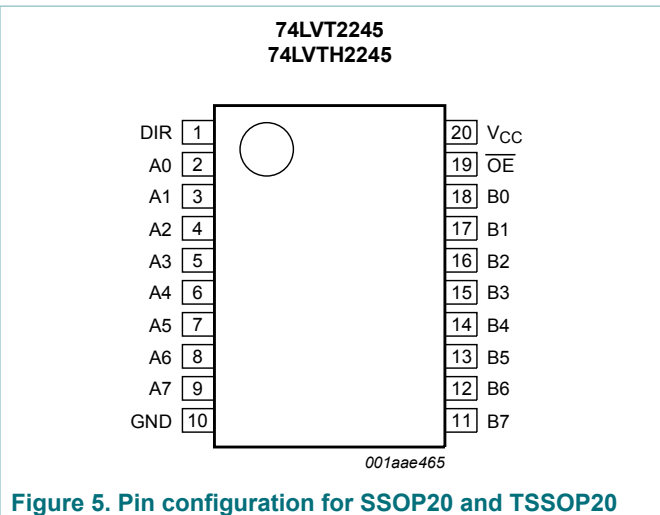


Figure 5. Pin configuration for SSOP20 and TSSOP20

5.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|--------------------------------|--------------------------------|-------------------------|
| DIR | 1 | direction control input |
| A0, A1, A2, A3, A4, A5, A6, A7 | 2, 3, 4, 5, 6, 7, 8, 9 | data input/output |
| GND | 10 | ground (0 V) |
| B7, B6, B5, B4, B3, B2, B1, B0 | 11, 12, 13, 14, 15, 16, 17, 18 | data input/output |
| OE | 19 | output enable input |
| V _{CC} | 20 | supply voltage |

6 Functional description

Table 3. Function table ^[1]

| Control | | Input/output | |
|---------|-----|----------------|----------------|
| OE | DIR | An | Bn |
| L | L | output An = Bn | input |
| L | H | input | output Bn = An |
| H | X | Z | Z |

[1] H = HIGH voltage level;
L = LOW voltage level;
X = don't care;
Z = high-impedance OFF-state.

7 Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|---------------------------------------|------|------|------|
| V _{CC} | supply voltage | | -0.5 | +4.6 | V |
| V _I | input voltage | [1] | -0.5 | +7.0 | V |
| V _O | output voltage | output in OFF-state or HIGH-state [1] | -0.5 | +7.0 | V |
| I _{IK} | input clamping current | V _I < 0 V | -50 | - | mA |
| I _{OK} | output clamping current | V _O < 0 V | -50 | - | mA |
| I _O | output current | output in LOW-state | - | 128 | mA |
| | | output in HIGH-state | -64 | - | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| T _j | junction temperature | [2] | - | 150 | °C |
| P _{tot} | total power dissipation | T _{amb} = -40 to +85 °C [3] | | 500 | mW |

[1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

[3] For SO20 package: above 70 °C derate linearly with 8 mW/K.
For (T)SSOP20 package: above 60 °C derate linearly with 5.5 mW/K.

8 Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|------------------|-------------------------------------|-----------------|-----|-----|-----|------|
| V _{CC} | supply voltage | | 2.7 | - | 3.6 | V |
| V _I | input voltage | | 0 | - | 5.5 | V |
| I _{OH} | HIGH-level output current | | -12 | - | - | mA |
| I _{OL} | LOW-level output current | | - | - | 12 | mA |
| Δt/ΔV | input transition rise and fall rate | outputs enabled | - | - | 10 | ns/V |
| T _{amb} | ambient temperature | in free-air | -40 | +25 | +85 | °C |

9 Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ ^[1] | Max | Unit |
|-------------------------------------|---------------------------|---|------|--------------------|-----|------|
| T _{amb} = -40 °C to +85 °C | | | | | | |
| V _{IK} | input clamping voltage | V _{CC} = 2.7 V; I _{IK} = -18 mA | -1.2 | -0.9 | - | V |
| V _{IH} | HIGH-level input voltage | | 2.0 | - | - | V |
| V _{IL} | LOW-level input voltage | | - | - | 0.8 | V |
| V _{OH} | HIGH-level output voltage | V _{CC} = 3.0 V; I _{OH} = -12 mA | 2.0 | 2.2 | - | V |

| Symbol | Parameter | Conditions | Min | Typ ^[1] | Max | Unit |
|--------------------------|------------------------------------|--|------|--------------------|-----------|---------|
| V _{OL} | LOW-level output voltage | V _{CC} = 3.0 V; I _{OL} = 12 mA | - | - | 0.8 | V |
| I _I | input leakage current | control pins | | | | |
| | | V _{CC} = 0 V or 3.6 V; V _I = 5.5 V | - | 1 | 10 | μ A |
| | | V _{CC} = 3.6 V; V _I = V _{CC} or GND | - | ± 0.1 | ± 1 | μ A |
| | | I/O data pins; V _{CC} = 3.6 V ^[2] | | | | |
| | | V _I = 5.5 V | - | 1 | 20 | μ A |
| | | V _I = V _{CC} | - | 0.1 | 1 | μ A |
| | | V _I = 0 V | - | -1 | -5 | μ A |
| I _{OFF} | power-off leakage current | V _{CC} = 0 V; V _I or V _O = 0 V to 4.5 V | - | 1 | ± 100 | μ A |
| I _{BHL} | bus hold LOW current | V _{CC} = 3 V; V _I = 0.8 V | 75 | 150 | - | μ A |
| I _{BHH} | bus hold HIGH current | V _{CC} = 3 V; V _I = 2.0 V | - | -150 | -75 | μ A |
| I _{BHLO} | bus hold LOW overdrive current | V _{CC} = 0 V to 3.6 V; V _I = 3.6 V ^[3] | - | - | 500 | μ A |
| I _{BHHO} | bus hold HIGH overdrive current | V _{CC} = 0 V to 3.6 V; V _I = 3.6 V ^[3] | -500 | - | - | μ A |
| I _{CEX} | output high leakage current | output in HIGH-state when V _O > V _{CC} ; V _O = 5.5 V; V _{CC} = 3.0 V | - | 60 | 125 | μ A |
| I _{O(pu/pd)} | power-up/power-down output current | V _{CC} \leq 1.2 V; V _O = 0.5 V to V _{CC} ; V _I = GND or V _{CC} ; \overline{OE} = don't care ^[4] | - | 15 | ± 100 | μ A |
| I _{CC} | supply current | V _{CC} = 3.6 V; V _I = GND or V _{CC} ; I _O = 0 A | | | | |
| | | outputs HIGH | - | 0.13 | 0.19 | mA |
| | | outputs LOW | - | 3 | 12 | mA |
| | | outputs disabled ^[5] | - | 0.13 | 0.19 | mA |
| Δ I _{CC} | additional supply current | per input pin; V _{CC} = 3 V to 3.6 V; one input at V _{CC} - 0.6 V; other inputs at V _{CC} or GND ^[6] | - | 0.1 | 0.2 | mA |
| C _I | input capacitance | DIR and \overline{OE} ; V _I = 0 V or 3.0 V | - | 4 | - | pF |
| C _{I/O} | input/output capacitance | An and Bn; outputs disabled; V _{I/O} = 0 V or 3.0 V | - | 10 | - | pF |

[1] Typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

[2] Unused pins at V_{CC} or GND.

[3] This is the bus hold overdrive current required to force the input to the opposite logic state.

[4] This parameter is valid for any V_{CC} between 0 V and 1.2 V with a transition time of up to 10 ms. From V_{CC} = 1.2 V to V_{CC} = 3.0 V to 3.6 V a transition time of 100 μ s is permitted.

[5] I_{CC} is measured with outputs pulled to V_{CC} or GND.

[6] This is the increase in supply current for each input at the specified voltage level other than V_{CC} or GND.

10 Dynamic characteristics

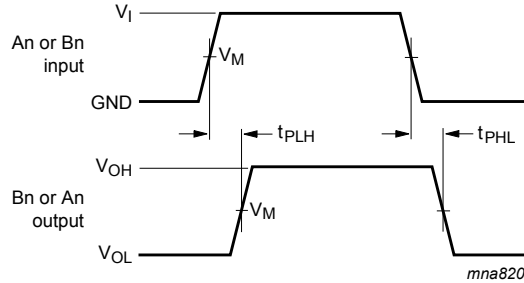
Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see [Figure 8](#).

| Symbol | Parameter | Conditions | Min | Typ ^[1] | Max | Unit |
|--|-------------------------------------|--|-----|--------------------|-----|------|
| $T_{amb} = -40\text{ }^{\circ}\text{C to }+85\text{ }^{\circ}\text{C}$ | | | | | | |
| t_{PLH} | LOW to HIGH propagation delay | An to Bn or Bn to An; see Figure 6 | | | | |
| | | $V_{CC} = 2.7\text{ V}$ | - | - | 5.3 | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 1.0 | 3.2 | 4.6 | ns |
| t_{PHL} | HIGH to LOW propagation delay | An to Bn or Bn to An; see Figure 6 | | | | |
| | | $V_{CC} = 2.7\text{ V}$ | - | - | 4.9 | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 1.0 | 3.1 | 4.5 | ns |
| t_{PZH} | OFF-state to HIGH propagation delay | see Figure 7 | | | | |
| | | $V_{CC} = 2.7\text{ V}$ | - | - | 9.1 | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 1.1 | 4.5 | 7.0 | ns |
| t_{PZL} | OFF-state to LOW propagation delay | see Figure 7 | | | | |
| | | $V_{CC} = 2.7\text{ V}$ | - | - | 7.6 | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 1.5 | 4.3 | 6.5 | ns |
| t_{PHZ} | HIGH to OFF-state propagation delay | see Figure 7 | | | | |
| | | $V_{CC} = 2.7\text{ V}$ | - | - | 5.6 | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 2.2 | 3.7 | 5.2 | ns |
| t_{PLZ} | LOW to OFF-state propagation delay | see Figure 7 | | | | |
| | | $V_{CC} = 2.7\text{ V}$ | - | - | 5.0 | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 2.0 | 3.6 | 5.0 | ns |

[1] Typical values are measured at $V_{CC} = 3.3\text{ V}$ and $T_{amb} = 25\text{ }^{\circ}\text{C}$.

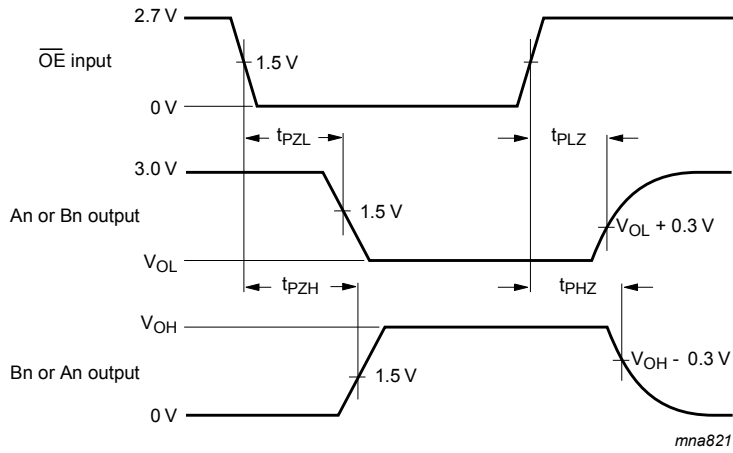
10.1 Waveforms and test circuit



$V_M = 1.5\text{ V}$

V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Figure 6. Input (An or Bn) to output (Bn or An) propagation delays



V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Figure 7. 3-state output enable and disable times

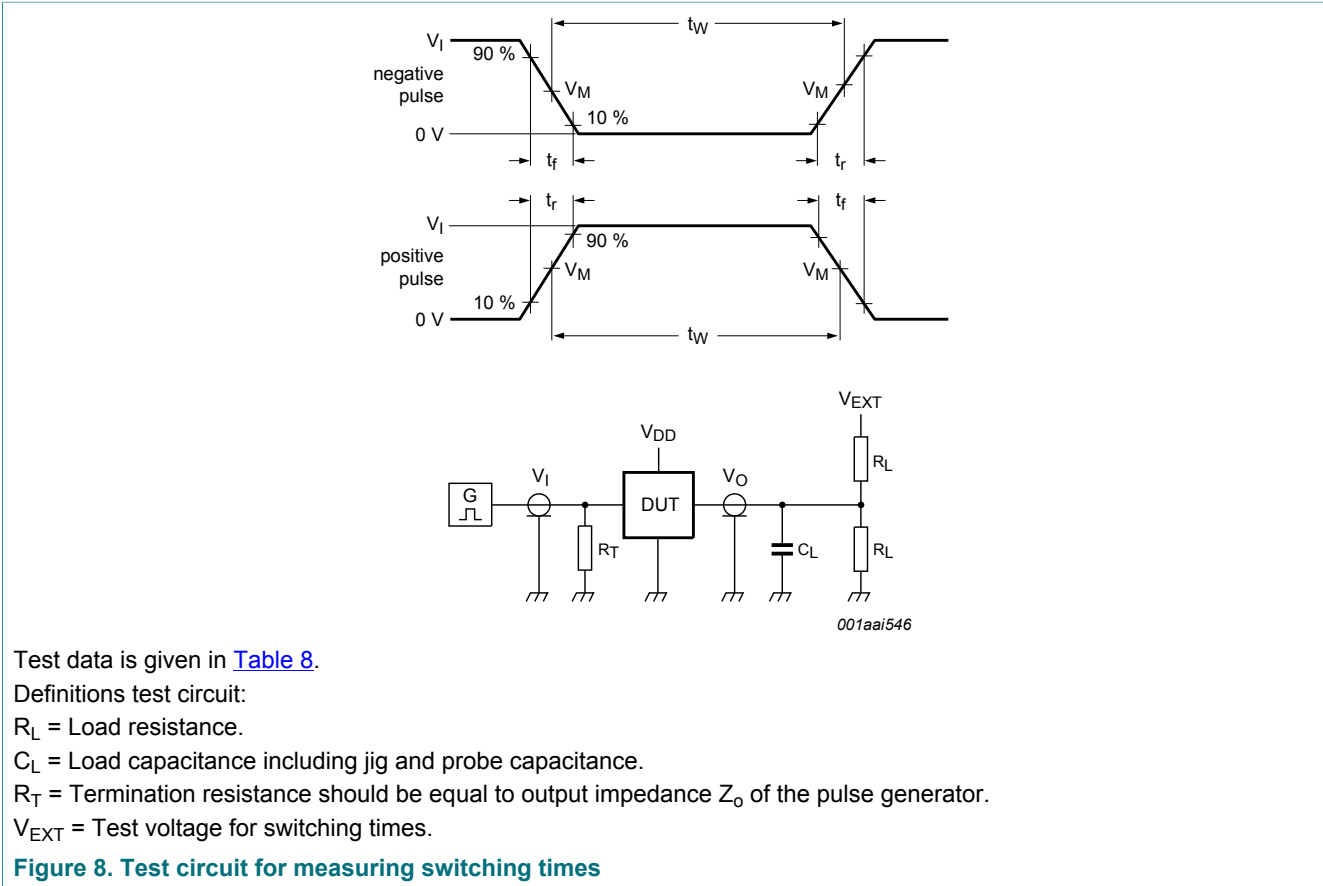


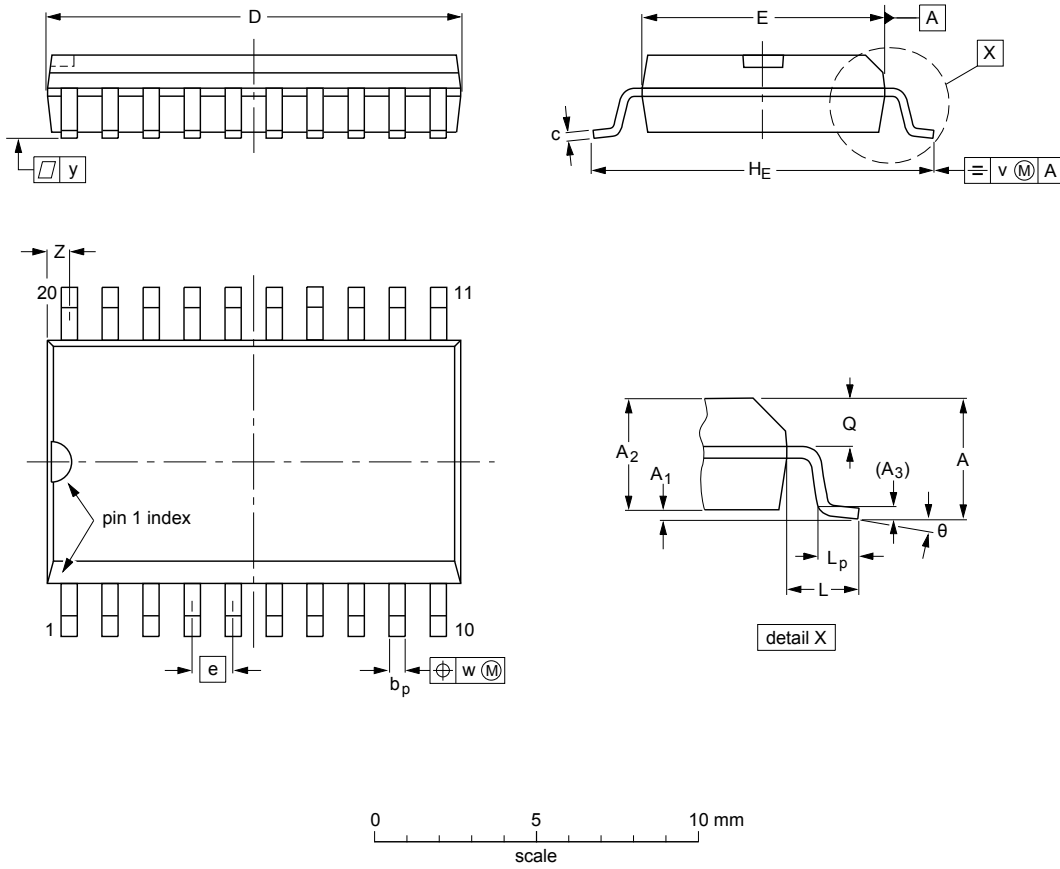
Table 8. Test data

| Input | | | | Load | | V_{EXT} | | |
|-------|----------|--------|------------|-------|-------|--------------------|--------------------|--------------------|
| V_I | f_i | t_W | t_r, t_f | C_L | R_L | t_{PHZ}, t_{PZH} | t_{PLZ}, t_{PZL} | t_{PLH}, t_{PHL} |
| 2.7 V | ≤ 10 MHz | 500 ns | ≤ 2.5 ns | 50 pF | 500 Ω | GND | 6 V | open |

11 Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽¹⁾ | e | H _E | L | L _p | Q | v | w | y | z ⁽¹⁾ | θ |
|--------|--------|----------------|----------------|----------------|----------------|----------------|------------------|------------------|------|----------------|-------|----------------|----------------|------|------|-------|------------------|----------|
| mm | 2.65 | 0.3 0.1 | 2.45 2.25 | 0.25 | 0.49 0.36 | 0.32 0.23 | 13.0 12.6 | 7.6 7.4 | 1.27 | 10.65 10.00 | 1.4 | 1.1 0.4 | 1.1 1.0 | 0.25 | 0.25 | 0.1 | 0.9 0.4 | 8° 0° |
| inches | 0.1 | 0.012 0.004 | 0.096 0.089 | 0.01 | 0.019 0.014 | 0.013 0.009 | 0.51 0.49 | 0.30 0.29 | 0.05 | 0.419 0.394 | 0.055 | 0.043 0.016 | 0.043 0.039 | 0.01 | 0.01 | 0.004 | 0.035 0.016 | |

Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|--------|-------|---------------------|----------------------|
| | IEC | JEDEC | JEITA | | |
| SOT163-1 | 075E04 | MS-013 | | | 99-12-27 03-02-19 |

Figure 9. Package outline SOT163-1 (SO20)

SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽¹⁾ | e | H _E | L | L _p | Q | v | w | y | Z ⁽¹⁾ | θ |
|------|--------|----------------|----------------|----------------|----------------|--------------|------------------|------------------|------|----------------|------|----------------|------------|-----|------|-----|------------------|----------|
| mm | 2 | 0.21 0.05 | 1.80 1.65 | 0.25 | 0.38 0.25 | 0.20 0.09 | 7.4 7.0 | 5.4 5.2 | 0.65 | 7.9 7.6 | 1.25 | 1.03 0.63 | 0.9 0.7 | 0.2 | 0.13 | 0.1 | 0.9 0.5 | 8° 0° |

Note

1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|--------|-------|--|---------------------|----------------------|
| | IEC | JEDEC | JEITA | | | |
| SOT339-1 | | MO-150 | | | | 99-12-27 03-02-19 |

Figure 10. Package outline SOT339-1 (SSOP20)

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽²⁾ | e | H _E | L | L _p | Q | v | w | y | Z ⁽¹⁾ | θ |
|------|--------|----------------|----------------|----------------|----------------|------------|------------------|------------------|------|----------------|---|----------------|------------|-----|------|-----|------------------|----------|
| mm | 1.1 | 0.15 0.05 | 0.95 0.80 | 0.25 | 0.30 0.19 | 0.2 0.1 | 6.6 6.4 | 4.5 4.3 | 0.65 | 6.6 6.2 | 1 | 0.75 0.50 | 0.4 0.3 | 0.2 | 0.13 | 0.1 | 0.5 0.2 | 8° 0° |

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|--------|-------|--|---------------------|-----------------------|
| | IEC | JEDEC | JEITA | | | |
| SOT360-1 | | MO-153 | | | | -99-12-27 03-02-19 |

Figure 11. Package outline SOT360-1 (TSSOP20)

12 Abbreviations

Table 9. Abbreviations

| Acronym | Description |
|---------|---|
| BiCMOS | Bipolar Complementary Metal Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MIL | Military |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |

13 Revision history

Table 10. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|--------------------|---|-----------------------|---------------|--------------------|
| 74LVT_LVTH2245 v.5 | 20170410 | Product data sheet | - | 74LVT_LVTH2245 v.4 |
| Modifications: | <ul style="list-style-type: none"> The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. | | | |
| 74LVT_LVTH2245 v.4 | 20060424 | Product data sheet | - | 74LVT_LVTH2245 v.3 |
| Modifications: | <ul style="list-style-type: none"> Text changes have been made to the parameter descriptions of t_{PLH} and t_{PHL} in the Quick reference and Dynamic characteristics tables. | | | |
| 74LVT_LVTH2245 v.3 | 20060323 | Product data sheet | - | 74LVT2245 v.2 |
| 74LVT2245 v.2 | 19980219 | Product specification | - | 74LVT2245 v.1 |
| 74LVT2245 v.1 | 19960311 | Product specification | - | - |

14 Legal information

14.1 Data sheet status

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

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Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

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- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
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- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

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- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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